

DESCRIPTION

The BAW56L is available in SOT-23 Package.

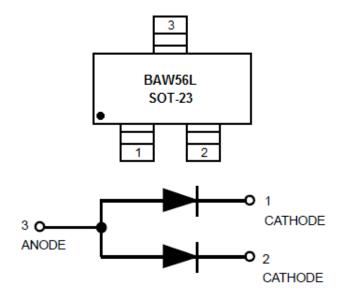
FEATURES

PIN DESCRIPTION

• Available in SOT-23 Package

ORDERING INFORMATION

Package Type	Part Number		
SOT-23	BAW56L		
Note	3,000pcs/Reel		
AiT provides all RoHS Compliant Products			





ABSOLUTE MAXIMUM RATINGS

EACH DIODE, T_A = 25°C

V _R , Reverse Voltage	70Vdc
I _F , Forward Current	200mAdc
I _{FM(surge)} , Peak Forward Surge Current	500mAdc

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Total Device Dissipation FR- 5 Board NOTE1			
$T_A = 25^{\circ}C$	PD	225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction to Ambient	R _{0JA}	556	°C/W
Total Device Dissipation Alumina Substrate NOTE2			
$T_A = 25^{\circ}C$	PD	300	mW
Derate above 25°C		2.4	mW/°C
Thermal Resistance, Junction to Ambient	Reja	417	°C/W
Junction and Storage Temperature	T」,T _{stg}	-55 ~ +150	°C

NOTE1: FR-5 = 1.0 x 0.75 x 0.062 in.

NOTE2: Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.



ELECTRICAL CHARACTERISTICS

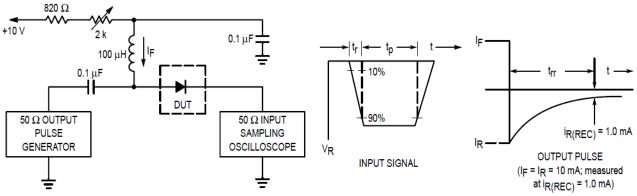
Parameter	Symbol	Conditions	Min.	Max.	Unit
OFF CHARACTERISTICS					
Reverse Breakdown Voltage	V _(BR)	I _(BR) = 100µAdc	70	-	Vdc
Reverse Voltage Leakage Current		V _R = 25Vdc, T _J = 150°C		30	µAdc
	IR	V _R = 70Vdc	-	2.5	
		V _R = 70Vdc, T _J = 150°C		50	
Diode Capacitance	CD	V _R = 0, f = 1.0MHz	-	2.0	pF
Forward Voltage	VF	l _F = 1.0mAdc		715	mVdc
		I⊧ = 10mAdc		855	
		I _F = 50mAdc	-	1000	
		I⊧ = 150mAdc		1250	
	4	$I_F = I_R = 10$ mAdc, $R_L = 100\Omega$		6.0	
Reverse Recovery Time	trr	I _{R(REC)} = 1.0mAdc (Figure 1)	-	6.0	ns

EACH DIODE, T_A = 25°C, unless otherwise noted



TYPICAL CHARACTERISTICS

Figure 1. Recovery Time Equivalent Test Circuit



NOTE: 1.A 2.0k Ω variable resistor adjusted for a Forward Current (I_F) of 10mA.

2. Input pulse is adjusted so $I_R(\text{peak})$ is equal to 10mA.

3. tp » trr

100

10

1.0

0.1

0.2

I_F, FORWARD CURRENT (mA)

CURVES APPLICABLE TO EACH CATHODE

Figure 2. Forward Voltage

Figure 3. Leakage Current

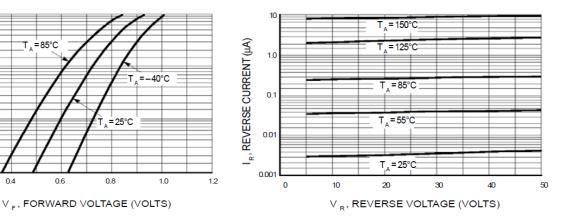
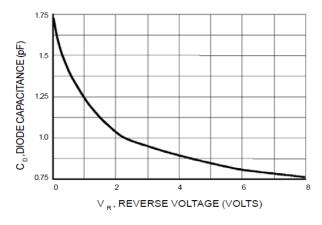


Figure 4. Capacitance

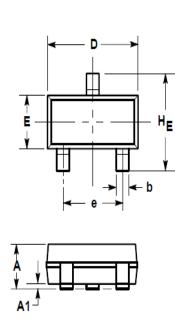
0.4

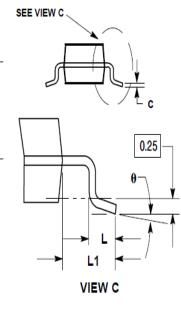




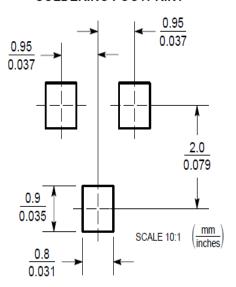
PACKAGE INFORMATION

Dimension in SOT-23 Package (Unit: mm)





SOLDERING FOOTPRINT



DIM	INCHES		MILLIMETERS		
	MIN	MAX	MIN	MAX	
А	0.035	0.044	0.89	1.11	
A1	0.001	0.004	0.01	0.10	
b	0.015	0.020	0.37	0.50	
с	0.003	0.007	0.09	0.18	
D	0.110	0.120	2.80	3.04	
E	0.047	0.055	1.20	1.40	
е	0.070	0.081	1.78	2.04	
L	0.004	0.012	0.10	0.30	
L1	0.014	0.029	0.35	0.69	
H _E	0.083	0.104	2.10	2.64	



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